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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

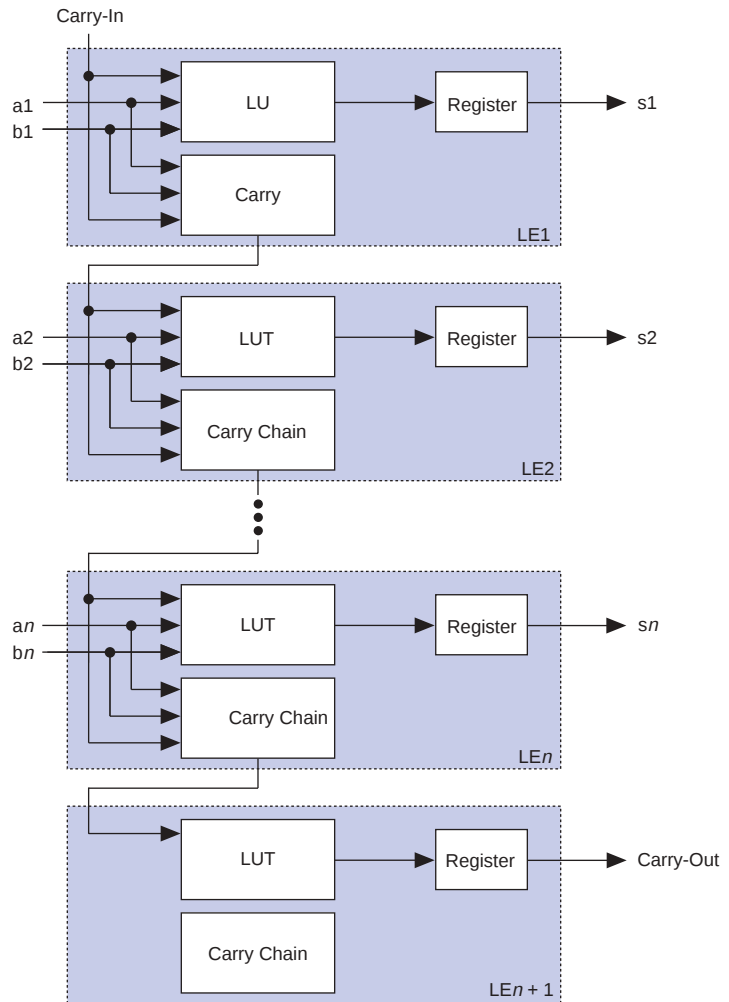
Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	63
Number of Logic Elements/Cells	504
Total RAM Bits	-
Number of I/O	136
Number of Gates	6000
Voltage - Supply	4.75V ~ 5.25V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C (TA)
Package / Case	208-BFQFP
Supplier Device Package	208-PQFP (28x28)
Purchase URL	https://www.e-xfl.com/product-detail/intel/epf8636aqc208-2

Figure 4. FLEX 8000 Carry Chain Operation

Cascade Chain

With the cascade chain, the FLEX 8000 architecture can implement functions that have a very wide fan-in. Adjacent LUTs can be used to compute portions of the function in parallel; the cascade chain serially connects the intermediate values. The cascade chain can use a logical AND or logical OR (via De Morgan's inversion) to connect the outputs of adjacent LEs. Each additional LE provides four more inputs to the effective width of a function, with a delay as low as 0.6 ns per LE.

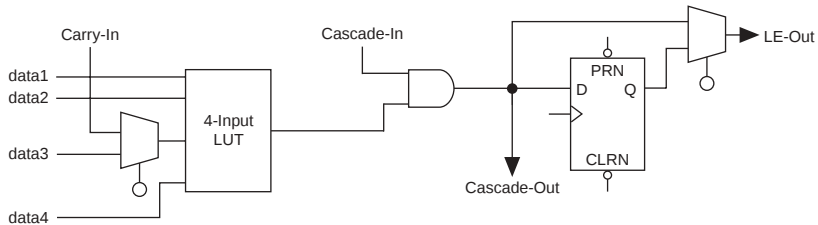
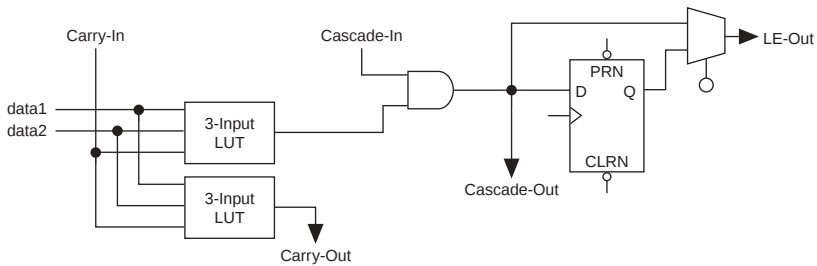
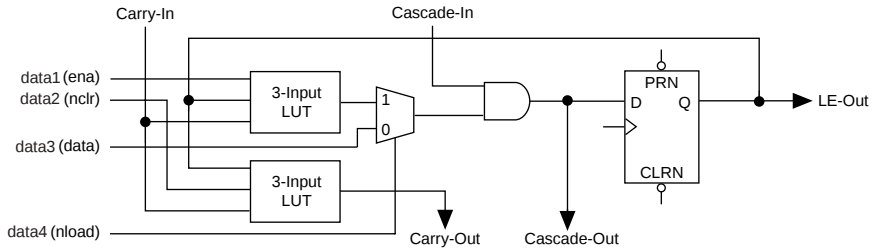
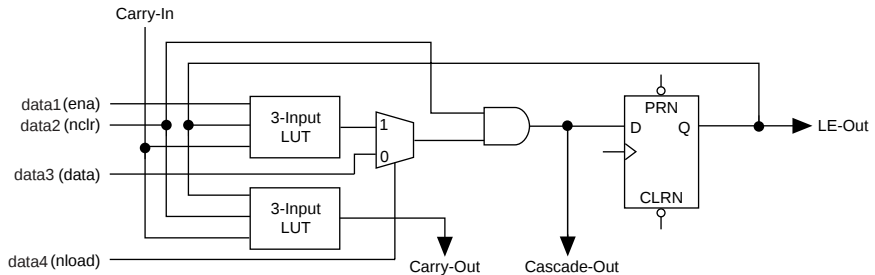
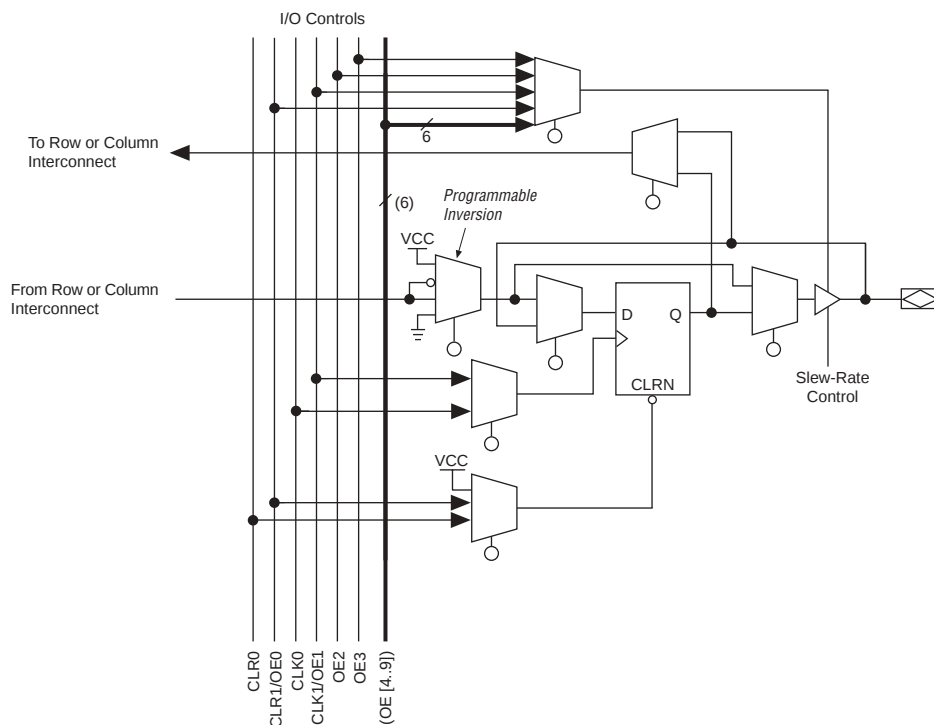
Figure 6. FLEX 8000 LE Operating Modes**Normal Mode****Arithmetic Mode****Up/Down Counter Mode****Clearable Counter Mode**

Figure 10. FLEX 8000 IOE

Numbers in parentheses are for EPF81500A devices only.

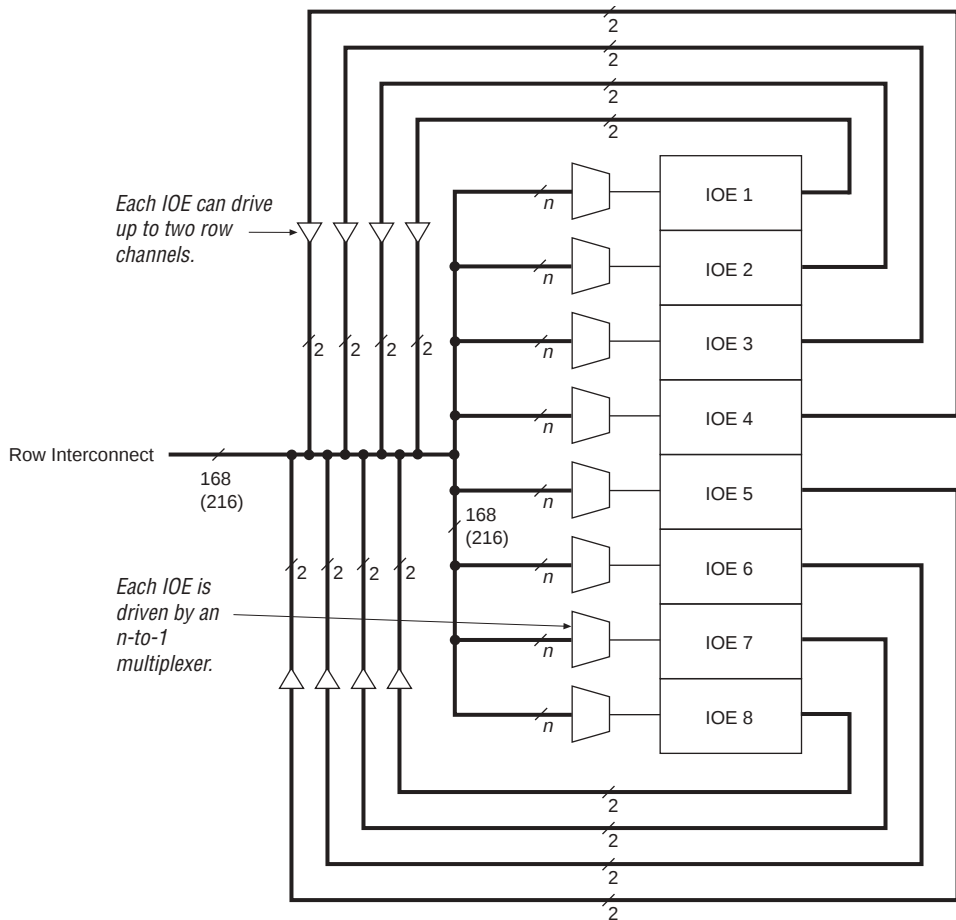


Row-to-IOE Connections

Figure 11 illustrates the connection between row interconnect channels and IOEs. An input signal from an IOE can drive two separate row channels. When an IOE is used as an output, the signal is driven by an n -to-1 multiplexer that selects the row channels. The size of the multiplexer varies with the number of columns in a device. EPF81500A devices use a 27-to-1 multiplexer; EPF81188A, EPF8820A, EPF8636A, and EPF8452A devices use a 21-to-1 multiplexer; and EPF8282A and EPF8282AV devices use a 13-to-1 multiplexer. Eight IOEs are connected to each side of the row channels.

Figure 11. FLEX 8000 Row-to-IOE Connections

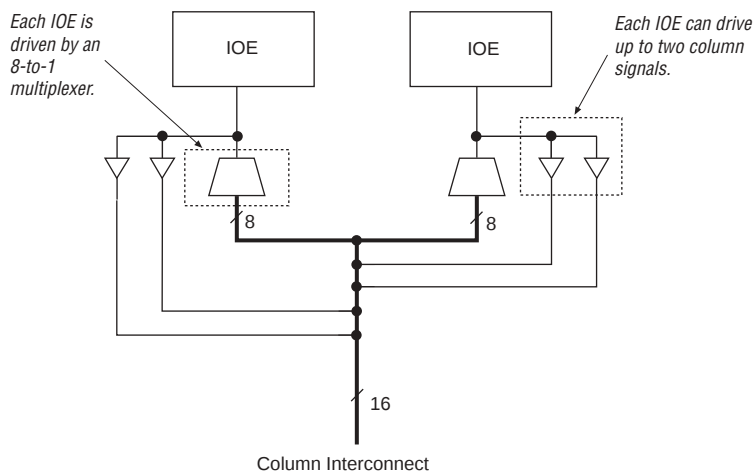
Numbers in parentheses are for EPF81500A devices. See [Note \(1\)](#).

**Note:**

- (1) $n = 13$ for EPF8282A and EPF8282AV devices.
 $n = 21$ for EPF8452A, EPF8636A, EPF8820A, and EPF81188A devices.
 $n = 27$ for EPF81500A devices.

Column-to-IOE Connections

Two IOEs are located at the top and bottom of the column channels (see [Figure 12](#)). When an IOE is used as an input, it can drive up to two separate column channels. The output signal to an IOE can choose from 8 of the 16 column channels through an 8-to-1 multiplexer.

Figure 12. FLEX 8000 Column-to-IOE Connections

In addition to general-purpose I/O pins, FLEX 8000 devices have four dedicated input pins. These dedicated inputs provide low-skew, device-wide signal distribution, and are typically used for global clock, clear, and preset control signals. The signals from the dedicated inputs are available as control signals for all LABs and I/O elements in the device. The dedicated inputs can also be used as general-purpose data inputs because they can feed the local interconnect of each LAB in the device.

Signals enter the FLEX 8000 device either from the I/O pins that provide general-purpose input capability or from the four dedicated inputs. The IOEs are located at the ends of the row and column interconnect channels.

I/O pins can be used as input, output, or bidirectional pins. Each I/O pin has a register that can be used either as an input register for external data that requires fast setup times, or as an output register for data that requires fast clock-to-output performance. The MAX+PLUS II Compiler uses the programmable inversion option to invert signals automatically from the row and column interconnect when appropriate.

The clock, clear, and output enable controls for the IOEs are provided by a network of I/O control signals. These signals can be supplied by either the dedicated input pins or by internal logic. The IOE control-signal paths are designed to minimize the skew across the device. All control-signal sources are buffered onto high-speed drivers that drive the signals around the periphery of the device. This “peripheral bus” can be configured to provide up to four output enable signals (10 in EPF81500A devices), and up to two clock or clear signals. [Figure 13 on page 22](#) shows how two output enable signals are shared with one clock and one clear signal.

Table 5 lists the source of the peripheral control signal for each FLEX 8000 device by row.

Table 5. Row Sources of FLEX 8000 Peripheral Control Signals

Peripheral Control Signal	EPF8282A EPF8282AV	EPF8452A	EPF8636A	EPF8820A	EPF81188A	EPF81500A
CLK0	Row A	Row A	Row A	Row A	Row E	Row E
CLK1/OE1	Row B	Row B	Row C	Row C	Row B	Row B
CLR0	Row A	Row A	Row B	Row B	Row F	Row F
CLR1/OE0	Row B	Row B	Row C	Row D	Row C	Row C
OE2	Row A	Row A	Row A	Row A	Row D	Row A
OE3	Row B	Row B	Row B	Row B	Row A	Row A
OE4	—	—	—	—	—	Row B
OE5	—	—	—	—	—	Row C
OE6	—	—	—	—	—	Row D
OE7	—	—	—	—	—	Row D
OE8	—	—	—	—	—	Row E
OE9	—	—	—	—	—	Row F

Output Configuration

This section discusses slew-rate control and MultiVolt I/O interface operation for FLEX 8000 devices.

Slew-Rate Control

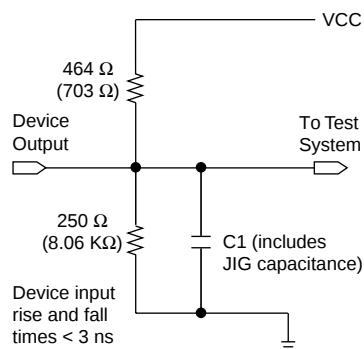
The output buffer in each IOE has an adjustable output slew rate that can be configured for low-noise or high-speed performance. A slow slew rate reduces system noise by slowing signal transitions, adding a maximum delay of 3.5 ns. The slow slew-rate setting affects only the falling edge of a signal. The fast slew rate should be used for speed-critical outputs in systems that are adequately protected against noise. Designers can specify the slew rate on a pin-by-pin basis during design entry or assign a default slew rate to all pins on a global basis.



For more information on high-speed system design, go to [Application Note 75 \(High-Speed Board Designs\)](#).

Figure 15. FLEX 8000 AC Test Conditions

Power supply transients can affect AC measurements. Simultaneous transitions of multiple outputs should be avoided for accurate measurement. Threshold tests must not be performed under AC conditions. Large-amplitude, fast-ground-current transients normally occur as the device outputs discharge the load capacitances. When these transients flow through the parasitic inductance between the device ground pin and the test system ground, significant reductions in observable noise immunity can result. Numbers in parentheses are for 3.3-V devices or outputs. Numbers without parentheses are for 5.0-V devices or outputs.

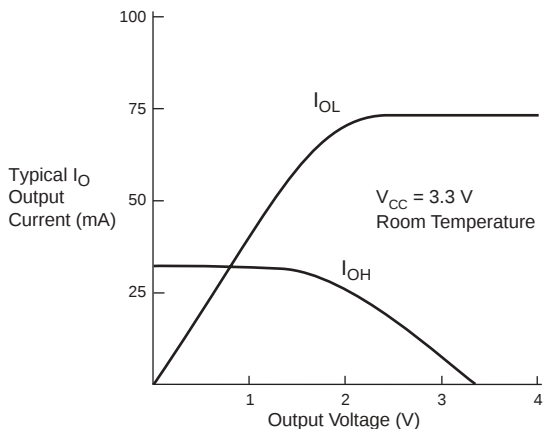


Operating Conditions

Tables 9 through 12 provide information on absolute maximum ratings, recommended operating conditions, operating conditions, and capacitance for 5.0-V FLEX 8000 devices.

Table 9. FLEX 8000 5.0-V Device Absolute Maximum Ratings *Note (1)*

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	Supply voltage	With respect to ground (2)	-2.0	7.0	V
V_I	DC input voltage		-2.0	7.0	V
I_{OUT}	DC output current, per pin		-25	25	mA
T_{STG}	Storage temperature	No bias	-65	150	° C
T_{AMB}	Ambient temperature	Under bias	-65	135	° C
T_J	Junction temperature	Ceramic packages, under bias		150	° C
		PQFP and RQFP, under bias		135	° C

Figure 18. Output Drive Characteristics of EPF8282AV Devices

Timing Model

The continuous, high-performance FastTrack Interconnect routing structure ensures predictable performance and accurate simulation and timing analysis. This predictable performance contrasts with that of FPGAs, which use a segmented connection scheme and hence have unpredictable performance. Timing simulation and delay prediction are available with the MAX+PLUS II Simulator and Timing Analyzer, or with industry-standard EDA tools. The Simulator offers both pre-synthesis functional simulation to evaluate logic design accuracy and post-synthesis timing simulation with 0.1-ns resolution. The Timing Analyzer provides point-to-point timing delay information, setup and hold time prediction, and device-wide performance analysis.

Tables 17 through 20 describe the FLEX 8000 timing parameters and their symbols.

Figure 19. FLEX 8000 Timing Model

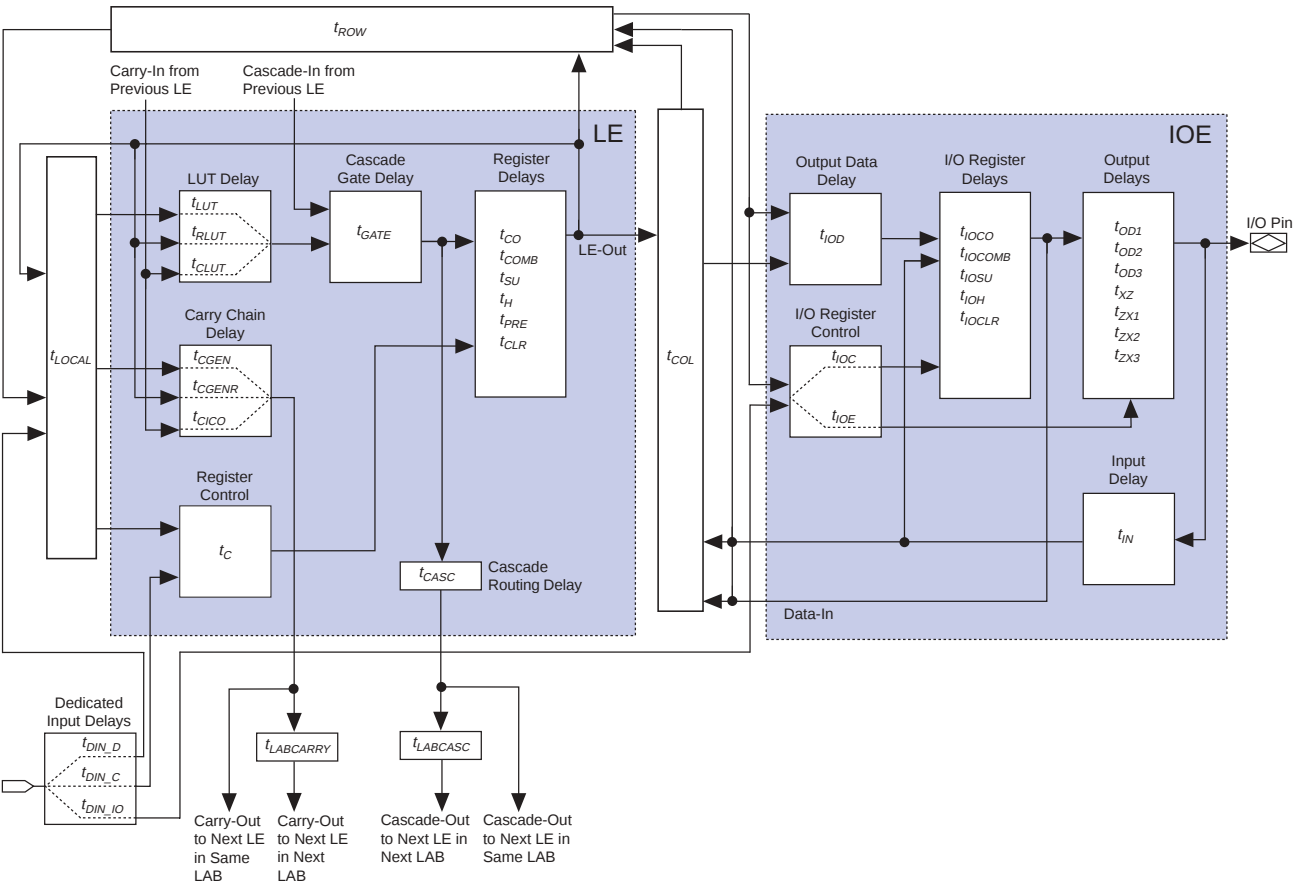


Table 24. EPF8282A LE Timing Parameters

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
t_{LUT}		2.0		2.5		3.2	ns
t_{CLUT}		0.0		0.0		0.0	ns
t_{RLUT}		0.9		1.1		1.5	ns
t_{GATE}		0.0		0.0		0.0	ns
t_{CASC}		0.6		0.7		0.9	ns
t_{CICO}		0.4		0.5		0.6	ns
t_{CGEN}		0.4		0.5		0.7	ns
t_{CGENR}		0.9		1.1		1.5	ns
t_C		1.6		2.0		2.5	ns
t_{CH}	4.0		4.0		4.0		ns
t_{CL}	4.0		4.0		4.0		ns
t_{CO}		0.4		0.5		0.6	ns
t_{COMB}		0.4		0.5		0.6	ns
t_{SU}	0.8		1.1		1.2		ns
t_H	0.9		1.1		1.5		ns
t_{PRE}		0.6		0.7		0.8	ns
t_{CLR}		0.6		0.7		0.8	ns

Table 25. EPF8282A External Timing Parameters

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
t _{DRR}		15.8		19.8		24.8	ns
t _{ODH}	1.0		1.0		1.0		ns

Table 26. EPF8282AV I/O Element Timing Parameters

Symbol	Speed Grade				Unit
	A-3		A-4		
	Min	Max	Min	Max	
t_{IOD}		0.9		2.2	ns
t_{IOC}		1.9		2.0	ns
t_{IOE}		1.9		2.0	ns
t_{IOCO}		1.0		2.0	ns
t_{IOCOMB}		0.1		0.0	ns
t_{IOSU}	1.8		2.8		ns
t_{IOH}	0.0		0.2		ns
t_{IOCLR}		1.2		2.3	ns
t_{IN}		1.7		3.4	ns
t_{OD1}		1.7		4.1	ns
t_{OD2}		—		—	ns
t_{OD3}		5.2		7.1	ns
t_{XZ}		1.8		4.3	ns
t_{ZX1}		1.8		4.3	ns
t_{ZX2}		—		—	ns
t_{ZX3}		5.3		8.3	ns

Table 27. EPF8282AV Interconnect Timing Parameters

Symbol	Speed Grade				Unit
	A-3		A-4		
	Min	Max	Min	Max	
$t_{LABCASC}$		0.4		1.3	ns
$t_{LABCARRY}$		0.4		0.8	ns
t_{LOCAL}		0.8		1.5	ns
t_{ROW}		4.2		6.3	ns
t_{COL}		2.5		3.8	ns
t_{DIN_C}		5.5		8.0	ns
t_{DIN_D}		7.2		10.8	ns
t_{DIN_IO}		5.5		9.0	ns

Table 28. EPF8282AV Logic Element Timing Parameters

Symbol	Speed Grade				Unit
	A-3		A-4		
	Min	Max	Min	Max	
t_{LUT}		3.2		7.3	ns
t_{CLUT}		0.0		1.4	ns
t_{RLUT}		1.5		5.1	ns
t_{GATE}		0.0		0.0	ns
t_{CASC}		0.9		2.8	ns
t_{CICO}		0.6		1.5	ns
t_{CGEN}		0.7		2.2	ns
t_{CGENR}		1.5		3.7	ns
t_C		2.5		4.7	ns
t_{CH}	4.0		6.0		ns
t_{CL}	4.0		6.0		ns
t_{CO}		0.6		0.9	ns
t_{COMB}		0.6		0.9	ns
t_{SU}	1.2		2.4		ns
t_H	1.5		4.6		ns
t_{PRE}		0.8		1.3	ns
t_{CLR}		0.8		1.3	ns

Table 29. EPF8282AV External Timing Parameters

Symbol	Speed Grade				Unit
	A-3		A-4		
	Min	Max	Min	Max	
t _{DRR}		24.8		50.1	ns
t _{ODH}	1.0		1.0		ns

Table 30. EPF8452A I/O Element Timing Parameters

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
t_{IOD}		0.7		0.8		0.9	ns
t_{IOC}		1.7		1.8		1.9	ns
t_{IOE}		1.7		1.8		1.9	ns
t_{IOCO}		1.0		1.0		1.0	ns
t_{IOCOMB}		0.3		0.2		0.1	ns
t_{IOSU}	1.4		1.6		1.8		ns
t_{IOH}	0.0		0.0		0.0		ns
t_{IOCLR}		1.2		1.2		1.2	ns
t_{IN}		1.5		1.6		1.7	ns
t_{OD1}		1.1		1.4		1.7	ns
t_{OD2}		—		—		—	ns
t_{OD3}		4.6		4.9		5.2	ns
t_{XZ}		1.4		1.6		1.8	ns
t_{ZX1}		1.4		1.6		1.8	ns
t_{ZX2}		—		—		—	ns
t_{ZX3}		4.9		5.1		5.3	ns

Table 31. EPF8452A Interconnect Timing Parameters

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
$t_{LABCASC}$		0.3		0.4		0.4	ns
$t_{LABCARRY}$		0.3		0.4		0.4	ns
t_{LOCAL}		0.5		0.5		0.7	ns
t_{ROW}		5.0		5.0		5.0	ns
t_{COL}		3.0		3.0		3.0	ns
t_{DIN_C}		5.0		5.0		5.5	ns
t_{DIN_D}		7.0		7.0		7.5	ns
t_{DIN_IO}		5.0		5.0		5.5	ns

Table 32. EPF8452A LE Timing Parameters

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
t_{LUT}		2.0		2.3		3.0	ns
t_{CLUT}		0.0		0.2		0.1	ns
t_{RLUT}		0.9		1.6		1.6	ns
t_{GATE}		0.0		0.0		0.0	ns
t_{CASC}		0.6		0.7		0.9	ns
t_{CICO}		0.4		0.5		0.6	ns
t_{CGEN}		0.4		0.9		0.8	ns
t_{CGENR}		0.9		1.4		1.5	ns
t_C		1.6		1.8		2.4	ns
t_{CH}	4.0		4.0		4.0		ns
t_{CL}	4.0		4.0		4.0		ns
t_{CO}		0.4		0.5		0.6	ns
t_{COMB}		0.4		0.5		0.6	ns
t_{SU}	0.8		1.0		1.1		ns
t_H	0.9		1.1		1.4		ns
t_{PRE}		0.6		0.7		0.8	ns
t_{CLR}		0.6		0.7		0.8	ns

Table 33. EPF8452A External Timing Parameters

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
t _{DRR}		16.0		20.0		25.0	ns
t _{ODH}	1.0		1.0		1.0		ns

Table 42. EPF81188A I/O Element Timing Parameters

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
t_{IOD}		0.7		0.8		0.9	ns
t_{IOC}		1.7		1.8		1.9	ns
t_{IOE}		1.7		1.8		1.9	ns
t_{IOCO}		1.0		1.0		1.0	ns
t_{IOCOMB}		0.3		0.2		0.1	ns
t_{IOSU}	1.4		1.6		1.8		ns
t_{IOH}	0.0		0.0		0.0		ns
t_{IOCLR}		1.2		1.2		1.2	ns
t_{IN}		1.5		1.6		1.7	ns
t_{OD1}		1.1		1.4		1.7	ns
t_{OD2}		1.6		1.9		2.2	ns
t_{OD3}		4.6		4.9		5.2	ns
t_{XZ}		1.4		1.6		1.8	ns
t_{ZX1}		1.4		1.6		1.8	ns
t_{ZX2}		1.9		2.1		2.3	ns
t_{ZX3}		4.9		5.1		5.3	ns

Table 43. EPF81188A Interconnect Timing Parameters

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
$t_{LABCASC}$		0.3		0.3		0.4	ns
$t_{LABCARRY}$		0.3		0.3		0.4	ns
t_{LOCAL}		0.5		0.6		0.8	ns
t_{ROW}		5.0		5.0		5.0	ns
t_{COL}		3.0		3.0		3.0	ns
t_{DIN_C}		5.0		5.0		5.5	ns
t_{DIN_D}		7.0		7.0		7.5	ns
t_{DIN_IO}		5.0		5.0		5.5	ns

Table 48. EPF81500A LE Timing Parameters

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
t_{LUT}		2.0		2.5		3.2	ns
t_{CLUT}		0.0		0.0		0.0	ns
t_{RLUT}		0.9		1.1		1.5	ns
t_{GATE}		0.0		0.0		0.0	ns
t_{CASC}		0.6		0.7		0.9	ns
t_{CICO}		0.4		0.5		0.6	ns
t_{CGEN}		0.4		0.5		0.7	ns
t_{CGENR}		0.9		1.1		1.5	ns
t_C		1.6		2.0		2.5	ns
t_{CH}	4.0		4.0		4.0		ns
t_{CL}	4.0		4.0		4.0		ns
t_{CO}		0.4		0.5		0.6	ns
t_{COMB}		0.4		0.5		0.6	ns
t_{SU}	0.8		1.1		1.2		ns
t_H	0.9		1.1		1.5		ns
t_{PRE}		0.6		0.7		0.8	ns
t_{CLR}		0.6		0.7		0.8	ns

Table 49. EPF81500A External Timing Parameters

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
t _{DRR}		16.1		20.1		25.1	ns
t _{ODH}	1.0		1.0		1.0		ns

Device Pin-Outs

Tables 52 through 54 show the pin names and numbers for the dedicated pins in each FLEX 8000 device package.

Table 52. FLEX 8000 84-, 100-, 144- & 160-Pin Package Pin-Outs (Part 1 of 3)

Pin Name	84-Pin PLCC EPF8282A	84-Pin PLCC EPF8452A EPF8636A	100-Pin TQFP EPF8282A EPF8282AV	100-Pin TQFP EPF8452A	144-Pin TQFP EPF8820A	160-Pin PGA EPF8452A	160-Pin PQFP EPF8820A (1)
nSP (2)	75	75	75	76	110	R1	1
MSEL0 (2)	74	74	74	75	109	P2	2
MSEL1 (2)	53	53	51	51	72	A1	44
nSTATUS (2)	32	32	24	25	37	C13	82
nCONFIG (2)	33	33	25	26	38	A15	81
DCLK (2)	10	10	100	100	143	P14	125
CONF_DONE (2)	11	11	1	1	144	N13	124
nWS	30	30	22	23	33	F13	87
nRS	48	48	42	45	31	C6	89
RDCLK	49	49	45	46	12	B5	110
nCS	29	29	21	22	4	D15	118
CS	28	28	19	21	3	E15	121
RDYnBUSY	77	77	77	78	20	P3	100
CLKUSR	50	50	47	47	13	C5	107
ADD17	51	51	49	48	75	B4	40
ADD16	36	55	28	54	76	E2	39
ADD15	56	56	55	55	77	D1	38
ADD14	57	57	57	57	78	E1	37
ADD13	58	58	58	58	79	F3	36
ADD12	60	60	59	60	83	F2	32
ADD11	61	61	60	61	85	F1	30
ADD10	62	62	61	62	87	G2	28
ADD9	63	63	62	64	89	G1	26
ADD8	64	64	64	65	92	H1	22
ADD7	65	65	65	66	94	H2	20
ADD6	66	66	66	67	95	J1	18
ADD5	67	67	67	68	97	J2	16
ADD4	69	69	68	70	102	K2	11
ADD3	70	70	69	71	103	K1	10
ADD2	71	71	71	72	104	K3	8
ADD1	76	72	76	73	105	M1	7

Table 52. FLEX 8000 84-, 100-, 144- & 160-Pin Package Pin-Outs (Part 2 of 3)

Pin Name	84-Pin PLCC EPF8282A	84-Pin PLCC EPF8452A EPF8636A	100-Pin TQFP EPF8282A EPF8282AV	100-Pin TQFP EPF8452A	144-Pin TQFP EPF8820A	160-Pin PGA EPF8452A	160-Pin PQFP EPF8820A (1)
ADD0	78	76	78	77	106	N3	6
DATA7	3	2	90	89	131	P8	140
DATA6	4	4	91	91	132	P10	139
DATA5	6	6	92	95	133	R12	138
DATA4	7	7	95	96	134	R13	136
DATA3	8	8	97	97	135	P13	135
DATA2	9	9	99	98	137	R14	133
DATA1	13	13	4	4	138	N15	132
DATA0	14	14	5	5	140	K13	129
SDOUT (3)	79	78	79	79	23	P4	97
TDI (4)	55	45 (5)	54	—	96	—	17
TD0 (4)	27	27 (5)	18	—	18	—	102
TCK (4), (6)	72	44 (5)	72	—	88	—	27
TMS (4)	20	43 (5)	11	—	86	—	29
TRST (7)	52	52 (8)	50	—	71	—	45
Dedicated Inputs (10)	12, 31, 54, 73	12, 31, 54, 73	3, 23, 53, 73	3, 24, 53, 74	9, 26, 82, 99	C3, D14, N2, R15	14, 33, 94, 113
VCCINT	17, 38, 59, 80	17, 38, 59, 80	6, 20, 37, 56, 70, 87	9, 32, 49, 59, 82	8, 28, 70, 90, 111	B2, C4, D3, D8, D12, G3, G12, H4, H13, J3, J12, M4, M7, M9, M13, N12	3, 24, 46, 92, 114, 160
VCCIO	—	—	—	—	16, 40, 60, 69, 91, 112, 122, 141	—	23, 47, 57, 69, 79, 104, 127, 137, 149, 159

Table 54. FLEX 8000 225-, 232-, 240-, 280- & 304-Pin Package Pin-Outs (Part 1 of 3)

Pin Name	225-Pin BGA EPF8820A	232-Pin PGA EPF81188A	240-Pin PQFP EPF81188A	240-Pin PQFP EPF81500A	280-Pin PGA EPF81500A	304-Pin RQFP EPF81500A
nSP (2)	A15	C14	237	237	W1	304
MSEL0 (2)	B14	G15	21	19	N1	26
MSEL1 (2)	R15	L15	40	38	H3	51
nSTATUS (2)	P2	L3	141	142	G19	178
nCONFIG (2)	R1	R4	117	120	B18	152
DCLK (2)	B2	C4	184	183	U18	230
CONF_DONE (2)	A1	G3	160	161	M16	204
nWS	L4	P1	133	134	F18	167
nRS	K5	N1	137	138	G18	171
RDCLK	F1	G2	158	159	M17	202
nCS	D1	E2	166	167	N16	212
CS	C1	E3	169	170	N18	215
RDYnBUSY	J3	K2	146	147	J17	183
CLKUSR	G2	H2	155	156	K19	199
ADD17	M14	R15	58	56	E3	73
ADD16	L12	T17	56	54	E2	71
ADD15	M15	P15	54	52	F4	69
ADD14	L13	M14	47	45	G1	60
ADD13	L14	M15	45	43	H2	58
ADD12	K13	M16	43	41	H1	56
ADD11	K15	K15	36	34	J3	47
ADD10	J13	K17	34	32	K3	45
ADD9	J15	J14	32	30	K4	43
ADD8	G14	J15	29	27	L1	34
ADD7	G13	H17	27	25	L2	32
ADD6	G11	H15	25	23	M1	30
ADD5	F14	F16	18	16	N2	20
ADD4	E13	F15	16	14	N3	18
ADD3	D15	F14	14	12	N4	16
ADD2	D14	D15	7	5	U1	8
ADD1	E12	B17	5	3	U2	6
ADD0	C15	C15	3	1	V1	4
DATA7	A7	A7	205	199	W13	254
DATA6	D7	D8	203	197	W14	252
DATA5	A6	B7	200	196	W15	250

Notes to tables:

- (1) Perform a complete thermal analysis before committing a design to this device package. See [Application Note 74 \(Evaluating Power for Altera Devices\)](#) for more information.
- (2) This pin is a dedicated pin and is not available as a user I/O pin.
- (3) SDOUT will drive out during configuration. After configuration, it may be used as a user I/O pin. By default, the MAX+PLUS II software will not use SDOUT as a user I/O pin; the user can override the MAX+PLUS II software and use SDOUT as a user I/O pin.
- (4) If the device is not configured to use the JTAG BST circuitry, this pin is available as a user I/O pin.
- (5) JTAG pins are available for EPF8636A devices only. These pins are dedicated user I/O pins.
- (6) If this pin is used as an input in user mode, ensure that it does not toggle before or during configuration.
- (7) TRST is a dedicated input pin for JTAG use. This pin must be grounded if JTAG BST is not used.
- (8) Pin 52 is a V_{CC} pin on EPF8452A devices only.
- (9) The user I/O pin count includes dedicated input pins and all I/O pins.
- (10) Unused dedicated inputs should be tied to ground on the board.
- (11) SDOUT does not exist in the EPF8636GC192 device.
- (12) These pins are no connect (N.C.) pins for EPF8636A devices only. They are user I/O pins in EPF8820A devices.
- (13) EPF8636A devices have 132 user I/O pins; EPF8820A devices have 148 user I/O pins.
- (14) For EPF81500A devices, these pins are dedicated JTAG pins and are not available as user I/O pins. If JTAG BST is not used, TDI, TCK, TMS, and TRST should be tied to GND.

Revision History

The information contained in the *FLEX 8000 Programmable Logic Device Family Data Sheet* version 11.1 supersedes information published in previous versions. The *FLEX 8000 Programmable Logic Device Family Data Sheet* version 11.1 contains the following change: minor textual updates.